



Docket No. A558MW (121116.00011)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kenneth R. Philpot

Serial No.: 09/873,059

Filing Date: 06/02/2001

Title: ENHANCED PERFORMANCE SURFACE MOUNT SEMICONDUCTOR PACKAGE DEVICES AND METHODS

TRANSMITTAL

Commissioner for Patents  
Washington, D.C. 20231

EXPRESS MAIL NO. EL 915821130 US

DATE OF DEPOSIT: April 11, 2003

Dear Sir:

Enclosed please find the following documents for filing with the U.S. Patent and Trademark Office:

1. Amendment;
2. Petition for Extension of Time;
3. Check in the amount of **\$930.00** to pay for the EOT; and
4. IDS with references and statement.

Respectfully submitted,

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PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Philpot, Kenneth R.

Serial No.: 09/873,059

Filed: 06/02/2001

Title: **ENHANCED PERFORMANCE SURFACE MOUNT  
SEMICONDUCTOR PACKAGE DEVICES AND METHODS**

Art Unit: 2827

Examiner: Luan Thai

Commissioner for Patents  
Box: Amendment  
Washington, D.C. 20231

Dear Sir or Madam:

I hereby certify under 37 CFR 1.8 that this correspondence is being deposited with the United States Postal Service by Express Mail No. EL915821130US addressed to: Commissioner for Patents, Washington, D.C. 20231.

Printed Name: Lisa Lynch

Signature: Lisa Lynch

**AMENDMENT UNDER 37 C.F.R. 1.111**

**Election/Restriction**

Applicant's election without traverse of group 1, claims 1-20 in Paper No. 7 filed 9/24/02 is acknowledged.

Responsive to the Office Action mailed October 22, 2002, please amend the above identified application as follows:

**In the Claims:**

**Claim 1:**

Please amend Claim 1 as follows:

(Once amended) 1. A surface-mount semiconductor device package comprising:  
a substrate having at least one planar surface;